

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### Features

- •High efficient lightsource.
- •Designed for high current operation.
- •Low thermal resistance.
- •Encapsulation : Silicone resin.
- •Compatible with IR-reflow processes.
- Moisture sensitivity level : level 4.
- •ESD protection.
- •RoHS compliant.

**Package Dimensions** 

Part Number: KADS-8072SY9Z4S Super Bright Yellow

#### Applications

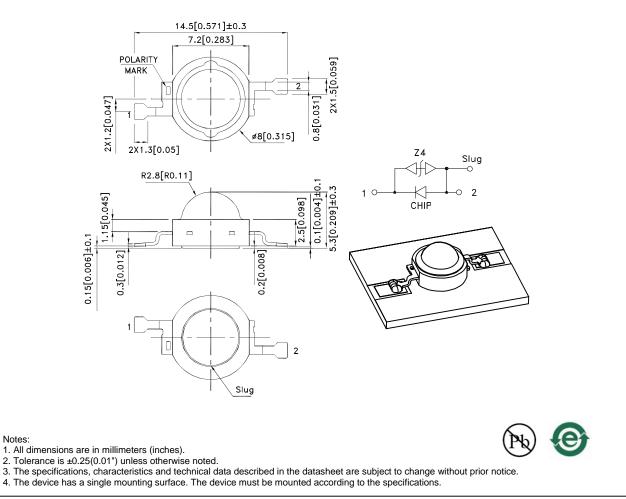
- Substitution of micro incandescent lamps.
- Portable light source.
- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Emergency-vehicle lighting.

#### **Application Note**

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.



#### SPEC NO: DSAM0390 APPROVED: WYNEC

REV NO: V.4B CHECKED: Allen Liu DATE: APR/03/2013 DRAWN: Y.Liu

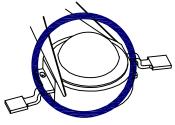
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#### **Handling Precautions**

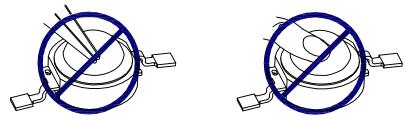
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated

- LED products. Failure to comply might lead to damage and premature failure of the LED.
- 1. Handle the component along the side surfaces by using forceps or appropriate tools.



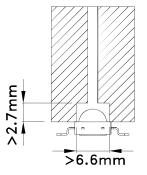
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. There should be enough space inside the nozzle to avoid contact with the dome lens during pick up.
- 4.2. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.3. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.4. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of Leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Detailed application notes are listed on our website. http://www.kingbright.com/application\_notes

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#### Flux Characteristics at 350mA Ambient Temperature, T<sub>a</sub> = 25°C

Color	Part No.	Luminous Flux (Im) @ 350mA [1]			
		Code.	Min.	Max.	Тур.
Super Bright Yellow (AlGaInP)	KADS-8072SY9Z4S	B7	29	35	- 42
		B8	35	42	
		B9	42	50	
		B10	50	60	

Note:

1. Minimum luminous flux performance guaranteed within published operating conditions. Kingbright maintains tolerance of +/-15% on flux. 2. Luminous Flux value is traceable to the CIE127-2007 compliant national standards.

### Optical Characteristics at 350mA Ambient Temperature, T<sub>a</sub> = 25°C

Color	Dominant Wavelength [1] $\lambda_D$ (nm)			Typical Spectral Halfwidth [2] (nm)	Typical Temperature Coefficient of Dominant Wavelength (nm/°C)	Typical Viewing Angle [3] (degrees) 201/2
	Min.	Тур.	Max.	Δλ1/2	$\Delta \lambda_{\rm D} / \Delta T$	
Super Bright Yellow	584	591	594	23	0.07	150°

Notes:

Dominant wavelength is derived from the CIE 1931 Chromaticity diagram and represents the perceived color.
Spectral width at 1/2 of the peak intensity.
Viewing angle is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Electrical Characteristics at 350mA Ambient Temperature, T<sub>a</sub> = 25°C

Color	Forward Voltage V <sub>f</sub> [1] (V)		Typical Temperature Coefficient of Forward Voltage [2] (mV/°C)	Typical Thermal Resistance (°C/W)		
	Min.	Тур.	Max.	$\Delta V_{f} / \Delta T$	R <sub>th j-slug</sub>	
Super Bright Yellow	1.8	2.3	2.8	-3.2	5	

Notes:

1.Kingbright maintains a tolerance of +/- 0.1V on forward voltage measurements.

3. Measured between 25°C  $\leq$  Tj  $\leq$  110 °C at IF = 350 mA.

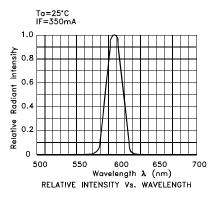
### **Absolute Maximum Ratings**

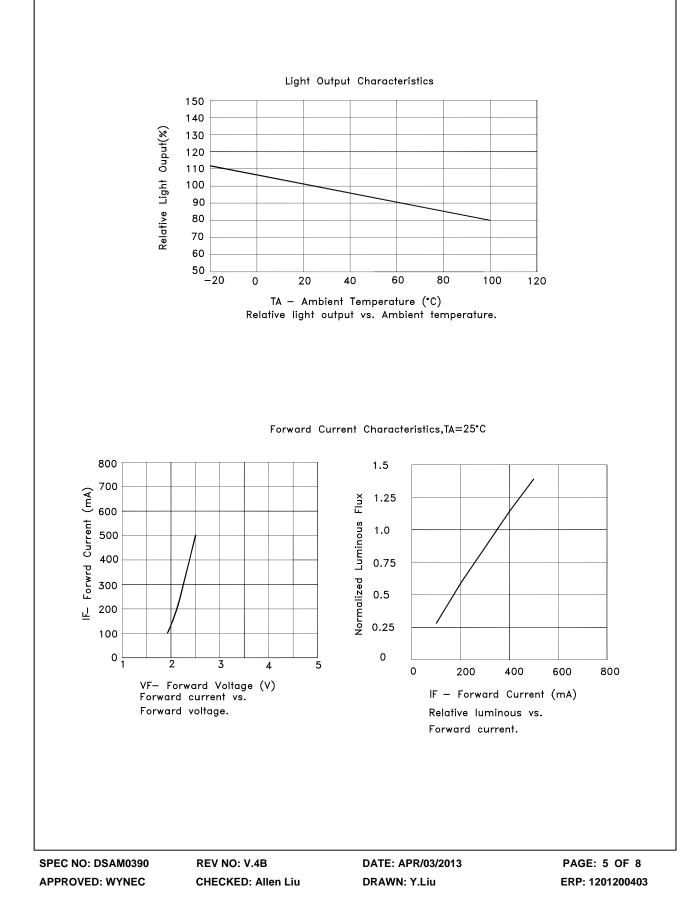
Super Bright Yellow		
500		
700		
500		
5		
8000V HBM		
110		
-40 to+100		
-40 to+110		
260 For 5 Seconds		

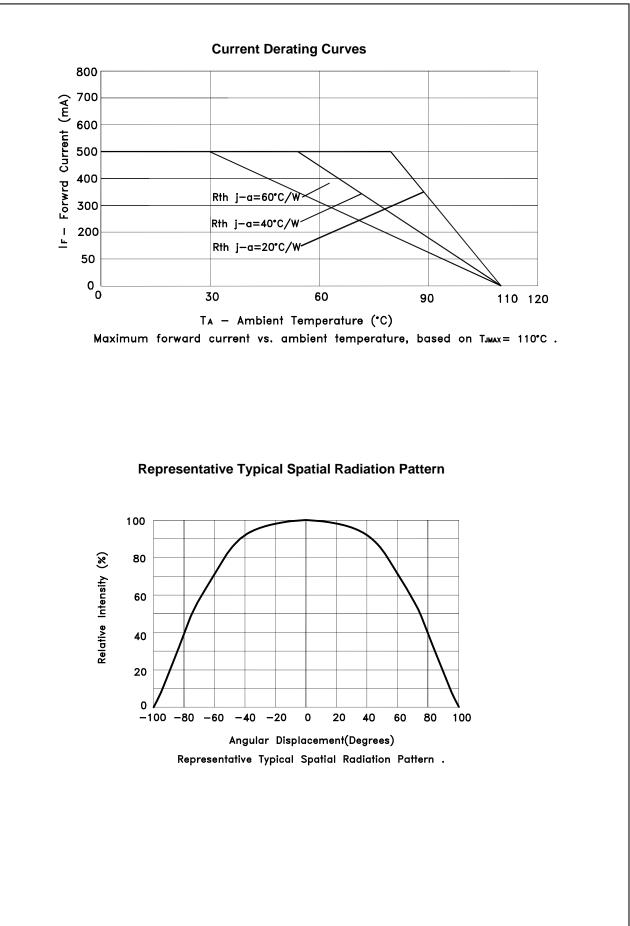
Notes:

1. Proper current derating must be observed to maintain junction temperature below the maximum.

### Wavelength Characteristics T<sub>a</sub> = 25°C

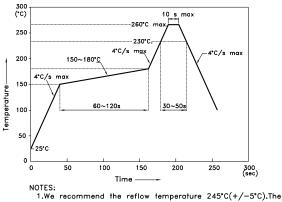






Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

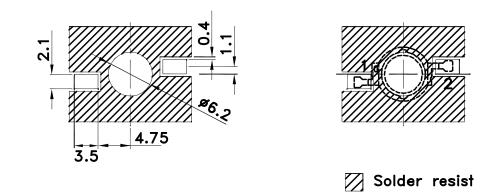
Reflow Soldering Profile For Lead-free SMT Process.



1.We recommend the reflow temperature  $245^{\circ}C(+/-5^{\circ}C)$ . The maximum soldering temperature should be limited to 260^{\circ}C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm ; Tolerance: ± 0.1)



- 1. Solder pad dimensions are as shown above.
- 2. Recommended solder paste stencil pattern dimensions:
- The center circular opening of the stencil (for the heat slug) should have the same size as the solder pad.
- Each side of the two rectangular openings (for the leads) should exceed those of the solder pads by 0.06 0.10 mm.
- Solder paste thickness should be greater than 0.25 mm.

